

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of: Christophe MALEVILLE et al.

Confirmation No.

Application No.:

Group Art Unit:

Filing Date:

Examiner:

For: METHOD FOR PREPARING A BONDING  
SURFACE OF A SEMICONDUCTOR LAYER OF  
A WAFER

Atty. Docket No.: 4717-10500

**INFORMATION DISCLOSURE STATEMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

Sir:


Pursuant to applicants' duty of disclosure under 37 C.F.R. 1.56, enclosed are copies of ( 4 ) references for the Examiner's review and consideration. These references were cited in the International Search Report for this application and a copy is enclosed.

These references are listed on the enclosed Form PTO-1449. It is respectfully requested that these references be made of record in this application by the Examiner's completion and return of the PTO Form 1449.

No fee or certification is believed to be due for this submission since the references are being submitted concurrent with the filing of this application. Should any fees be required, however, please charge such fees to **Winston & Strawn LLP** Deposit Account No. 50-1814.

Respectfully submitted,

Date: 3-25-2004

  
Allan A. Fanucci (Reg. No. 30,256)

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Enclosures

|  |                       |                  |
|--|-----------------------|------------------|
|  | ATTY. DOCKET NO.:     | APPLICATION NO.: |
|  | 81421-4038            |                  |
|  | APPLICANT:            |                  |
|  | Steen Ørsted ANDERSEN |                  |
|  | FILING DATE:          | GROUP:           |
|  | March 9, 2004         |                  |

## U.S. PATENT DOCUMENTS

| *EXAMINER<br>INITIAL |    | DOCUMENT NUMBER | DATE    | NAME            | CLASS | SUBCLASS | FILING DATE IF<br>APPROPRIATE |
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## FOREIGN PATENT DOCUMENTS

|  |    | DOCUMENT NUMBER | DATE | COUNTRY | CLASS | SUBCLASS | TRANSLATION |    |
|--|----|-----------------|------|---------|-------|----------|-------------|----|
|  |    |                 |      |         |       |          | YES         | NO |
|  | AE |                 |      |         |       |          |             |    |
|  | AF |                 |      |         |       |          |             |    |
|  | AG |                 |      |         |       |          |             |    |
|  | AH |                 |      |         |       |          |             |    |
|  | AI |                 |      |         |       |          |             |    |

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|  |    |   |

|          |                 |
|----------|-----------------|
| EXAMINER | DATE CONSIDERED |
|----------|-----------------|

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

**ANNEXE AU RAPPORT DE RECHERCHE PRÉLIMINAIRE  
RELATIF A LA DEMANDE DE BREVET FRANÇAIS NO. FR 0303699 FA 632630**

La présente annexe indique les membres de la famille de brevets relatifs aux documents brevets cités dans le rapport de recherche préliminaire visé ci-dessus.  
Les dits membres sont contenus au fichier informatique de l'Office européen des brevets à la date du 03-12-2003  
Les renseignements fournis sont donnés à titre indicatif et n'engagent pas la responsabilité de l'Office européen des brevets, ni de l'Administration française

| Document brevet cité<br>au rapport de recherche | Date de<br>publication | Membre(s) de la<br>famille de brevet(s) | Date de<br>publication |
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